TOSHIBA TPCP8201

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS III)/w.DataSheet4U.com

TPCP8201

Portable Equipment Applications Motor Drive Applications DC-DC Converter Applications

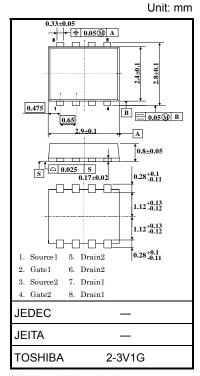
- Lead(Pb)-Free
- Low drain-source ON resistance
 - : RDS (ON) = $38 \text{ m}\Omega$ (typ.)
- High forward transfer admittance
 - $|Y_{fs}| = 7.0 \text{ S (typ.)}$
- Low leakage current
 - $: I_{DSS} = 10 \,\mu A \,(V_{DS} = 30 \,V)$
- Enhancement mode
 - : $V_{th} = 1.3 \text{ to } 2.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{mA})$

Maximum Ratings (Ta = 25°C)

| CI | naracteristics | Symbol | Rating | Unit | | |
|--|---|---------------------|---------|------|--|--|
| Drain-source v | voltage | V_{DSS} | 30 | V | | |
| Drain-gate vol | tage (R _{GS} = 20 kΩ) | V _{DGR} | 30 | V | | |
| Gate-source v | oltage | V _{GSS} | ±20 | V | | |
| Drain current | DC (Note 1) | I _D | 4.2 | Α | | |
| Dialii Cuiteiii | Pulse (Note 1) | I _{DP} | 16.8 | A | | |
| Drain power | Single-device operation (Note 3a) | P _{D (1)} | 1.48 | | | |
| dissipation (t = 5 s) (Note 2a) | Single-device value at dual operation (Note 3b) | P _{D (2)} | 1.23 | W | | |
| Drain power dissipation | Single-device operation (Note 3a) | P _{D (1)} | 0.58 | VV | | |
| (t = 5 s) (Note 2b) | Single-device value at dual operation (Note 3b) | P _{D (2)} | 0.36 | | | |
| Single pulse a (Note 4) | valanche energy | E _{AS} | 2.86 | mJ | | |
| Avalanche cur | rent | I _{AR} 2.1 | | Α | | |
| Repetitive avalanche energy Single-device value at dual operation (Note 2a, 3b, 5) | | Ear | 0.12 | mJ | | |
| Channel temp | erature | T _{ch} | 150 °C | | | |
| Storage temper | erature range | T _{stg} | -55~150 | °C | | |

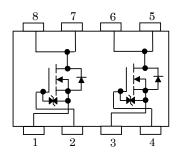
Note: For Notes 1 to 6, refer to the next page.

This transistor is an electrostatic-sensitive device. Handle with caution.

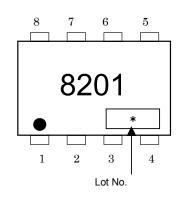


Weight: 0.017 g (typ.)

Circuit Configuration



Marking (Note 6)



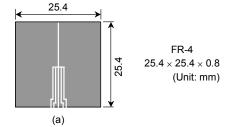


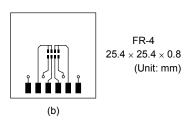
Thermal Characteristics

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| Characteristics | | Symbol | Max | Unit | |
|--|---|----------------------------|-------|------|--|
| Thermal resistance, channel to ambient (t = 5 s) (Note 2a) | Single-device operation (Note 3a) | R _{th (ch-a) (1)} | 84.5 | °C/W | |
| | Single-device value at dual operation (Note 3b) | R _{th (ch-a) (2)} | 101.6 | | |
| Thermal resistance, channel to ambient | Single-device operation (Note 3a) | R _{th (ch-a) (1)} | 215.5 | °C/W | |
| (t = 5 s) (Note 2b) | Single-device value at dual operation (Note 3b) | R _{th (ch-a) (2)} | 347.2 | G/VV | |

- Note 1: The channel temperature should not exceed 150°C during use.
- Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)





- Note 3: a) The power dissipation and thermal resistance values shown are for a single device. (During single-device operation, power is only applied to one device.)
 - b) The power dissipation and thermal resistance values shown are for a single device. (During dual operation, power is evenly applied to both devices.)
- Note 4: $V_{DD} = 24 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, $R_G = 25 \Omega$, $I_{AR} = 2.1 \text{ A}$
- Note 5: Repetitive rating: pulse width limited by maximum channel temperature.
- Note 6: on the lower left of the marking indicates Pin 1.
 - Weekly code (3 digits):



Week of manufacture

(01 for the first week of the year, continuing up to 52 or 53)

Year of manufacture

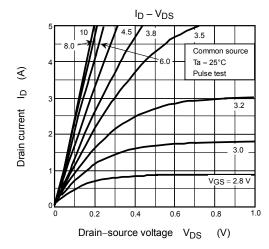
(The last digit of the calendar year)

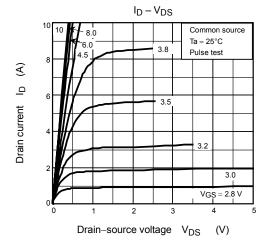
Electrical Characteristics (Ta = 25°C)

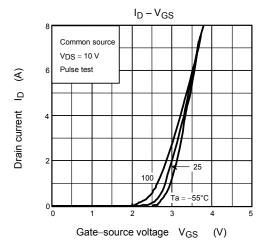
| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit | |
|---|--|----------------------|--|-----|------|-----|-------|--|
| Gate leakage cur | e leakage current | | V _{GS} = ±16 V, V _{DS} = 0 V | _ | _ | ±10 | μA | |
| Drain cut-off curre | ent | I _{DSS} | V _{DS} = 30 V, V _{GS} = 0 V | 10 | | μA | | |
| Drain-source brea | $V_{(BR) DSX} = 10 \text{ mA}, V_{GS} = -20 \text{ V}$ | | I _D = 10 mA, V _{GS} = 0 V | 30 | _ | _ | V | |
| voltage | | | 15 | _ | _ | V | | |
| Gate threshold vo | oltage | V _{th} | V _{DS} = 10 V, I _D = 1 mA | 1.3 | _ | 2.5 | V | |
| Drain sauras ON | registeres | Б | V _{GS} = 4.5 V, I _D = 2.1 A | _ | 58 | 77 | 0 | |
| Drain-source ON resistance | | R _{DS} (ON) | V _{GS} = 10 V, I _D = 2.1 A | _ | 38 | 50 | mΩ | |
| Forward transfer admittance | | Y _{fs} | V _{DS} = 10 V, I _D = 2.1 A | 3.5 | 7.0 | _ | S | |
| Input capacitance | : | C _{iss} | V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz | | 470 | _ | pF | |
| Reverse transfer | capacitance | C _{rss} | | | 60 | _ | | |
| Output capacitance | | Coss | | _ | 80 | _ | | |
| Switching time | Rise time | t _r | $V_{GS} = 2.1 \text{ A}$ $V_{GS} = 0 \text{ V}$ $V_{DD} \approx 15 \text{ V}$ $V_{DD} \approx 15 \text{ V}$ $V_{DD} \approx 10 \mu\text{s}$ | _ | 5.2 | _ | | |
| | Turn-on time | t _{on} | | | 8.3 | _ | ns | |
| | Fall time | t _f | | _ | 4.0 | _ | ns ns | |
| | Turn-off time | t _{off} | | _ | 22 | _ | | |
| Total gate charge (gate-source plus gate-drain) | | Qg | V _{DD} ≈ 24 V, V _{GS} = 10 V, I _D = 6 A | _ | 10 | _ | nC | |
| Gate-source charge 1 | | Q _{gs1} | | | 1.7 | _ | | |
| Gate-drain ("miller") charge | | Q _{gd} | | _ | 2.4 | _ | | |

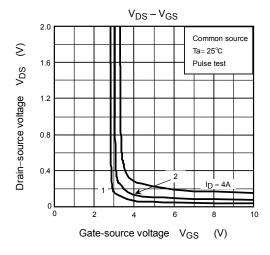
Source-Drain Ratings and Characteristics (Ta = 25°C)

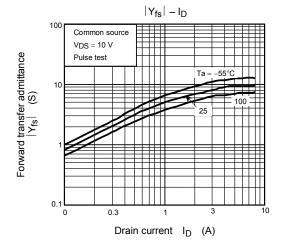
| Characteristi | ics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-------------------------|----------------|------------------|--|-----|------|------|------|
| Drain reverse current | Pulse (Note 1) | I _{DRP} | _ | _ | _ | 16.8 | Α |
| Forward voltage (diode) | | V_{DSF} | $I_{DR} = 4.2 \text{ A}, V_{GS} = 0 \text{ V}$ | _ | | -1.2 | V |

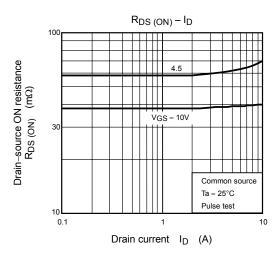


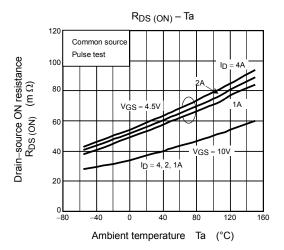


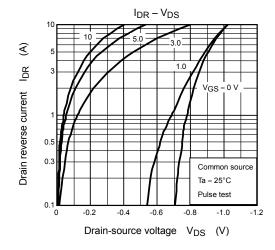


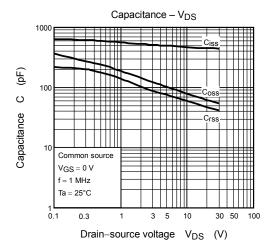


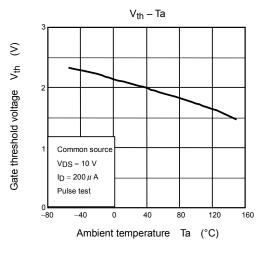


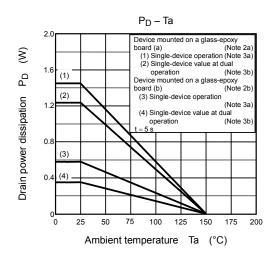


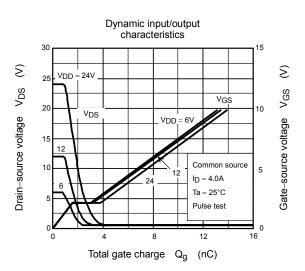


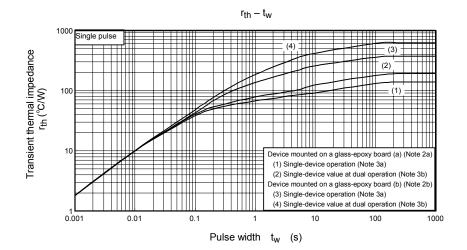


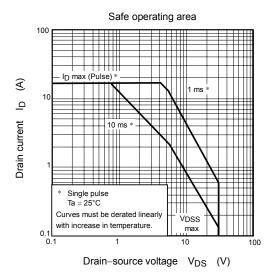












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